

# **GBU6A - GBU6M**

#### **Features**

- Glass passivated junction.
- Surge overload rating: 175 amperes peak.
- Reliable low cost construction utilizing molded plastic technique.
- Ideal for printed circuit board.
- UL certified, UL #E111753.



## **Bridge Rectifiers**

### Absolute Maximum Ratings\*

T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value						Units	
		6A	6B	6D	6G	6J	6K	6M	
$V_{RRM}$	Maximum Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V
V <sub>RMS</sub>	Maximum RMS Bridge Input Voltage	35	70	140	280	420	560	700	V
$V_R$	DC Reverse Voltage (Rated V <sub>R</sub> )	50	100	200	400	600	800	1000	V
I <sub>F(AV)</sub>	Average Rectified Forward Current, @ T <sub>A</sub> = 100°C	6.0		Α					
I <sub>FSM</sub>	Non-repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave	175		А					
T <sub>stg</sub>	Storage Temperature Range -55 to +150			°C					
T <sub>J</sub>	Operating Junction Temperature -55 to +150			°C					

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

### **Thermal Characteristics**

Symbol	Parameter	Value	Units
$P_D$	Power Dissipation	12	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient,* per leg	18.6	°C/W
R <sub>eJL</sub>	Thermal Resistance, Junction to Lead,** per leg	3.1	°C/W

Device mounted on PCB with 0.5 x 0.5" (12 x 12 mm).

## **Electrical Characteristics** $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Device	Units
V <sub>F</sub>	Forward Voltage, per element @ 6.0 A	1.0	V
I <sub>R</sub>	Reverse Current, per element @ rated $V_R$ $T_A = 25^{\circ}C$ $T_A = 125^{\circ}C$	5.0 500	μA μA
	I <sup>2</sup> t rating for fusing t < 8.35 ms	127	A <sup>2</sup> s

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<sup>\*\*</sup>Device mounted on Al plate with 2.6 x 1.4" x 0.06" (6,5 x 3.5 x 0.15 cm).

### **Bridge Rectifiers**

(continued)

## **Typical Characteristics**

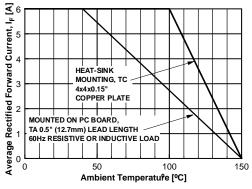


Figure 1. Forward Current Derating Curve

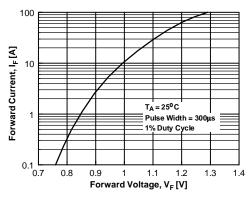


Figure 2. Forward Voltage Characteristics

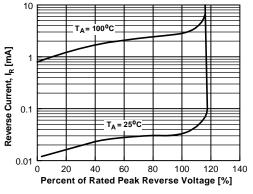


Figure 3. Reverse Current vs Reverse Voltage

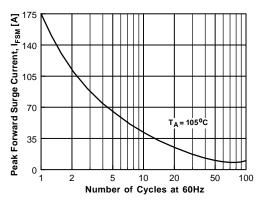


Figure 4. Non-Repetitive Surge Current

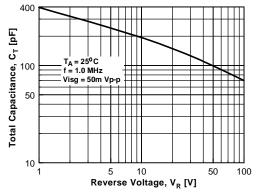


Figure 5. Total Capacitance

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